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What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Obsolete
Core Processor	RXv2
Core Size	32-Bit Single-Core
Speed	120MHz
Connectivity	CANbus, EBI/EMI, Ethernet, I²C, LINbus, MMC/SD, SCI, SPI, SSI, UART/USART, USB
Peripherals	DMA, LVD, POR, PWM, WDT
Number of I/O	111
Program Memory Size	2MB (2M x 8)
Program Memory Type	FLASH
EEPROM Size	64K x 8
RAM Size	552K x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 3.6V
Data Converters	A/D 29x12b; D/A 2x12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	144-LQFP
Supplier Device Package	144-LFQFP (20x20)
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f564mfhdfb-v1

Table 1.1 Outline of Specifications (6/9)

Classification	Module/Function	Description
Communication function	Ethernet controller (ETHERC)	• 2 channels • Input and output of Ethernet/IEEE 802.3 frames • Transfer at 10 or 100 Mbps • Full- and half-duplex modes • MII (Media Independent Interface) or RMII (Reduced Media Independent Interface) as defined in IEEE 802.3u • Detection of Magic Packets™*1 or output of a "wake-on-LAN" signal (WOL) • Compliance with flow control as defined in IEEE 802.3x standards • Filtering of multicast frames • Direct transfer of frames between two channels by cut-through
	PTP controller for Ethernet controller (EPTPC)	• A block compatible with the IEEE 1588 standard is connected to the Ethernet controller (ETHERC). • Matching with a time stamp can start counting by MTU3 and the GPT.
	DMA controller for Ethernet controller (EDMACa)	• 3 channels (the round-robin method determines the priority of the channels) 2 channels for ETHERC; 1 channel for EPTPC • Alleviation of CPU load by the descriptor control method • Transmission FIFO: 2 Kbytes; Reception FIFO: 4 Kbytes
	USB 2.0 FS host/ function module (USBb)	• Includes a UDC (USB Device Controller) and transceiver for USB 2.0 FS • One port • Compliance with the USB 2.0 specification • Transfer rate: Full speed (12 Mbps), low speed (1.5 Mbps) (host only) • Both self-power mode and bus power are supported • OTG (On the Go) operation is possible (low-speed is not supported) • Incorporates 2 Kbytes of RAM as a transfer buffer • External pull-up and pull-down resistors are not required
	USB 2.0 FS host/ function module with battery charging (USBA)	• Includes a UDC (USB Device Controller) and transceiver for USB 2.0 FS • One port (only in 176-pin devices) • Compliance with the USB 2.0 specification • Transfer rate: Full speed (12 Mbps), low speed (1.5 Mbps) (host only) • Both self-power mode and bus power are supported • OTG (On the Go) operation is possible (low-speed is not supported) • Incorporates 8.5 Kbytes of RAM as a transfer buffer • External pull-up and pull-down resistors are not required
	Serial communications interfaces (SCIg, SCIh)	• 9 channels (SCIg: 8 channels + SCIh: 1 channel) • SCIg Serial communications modes: Asynchronous, clock synchronous, and smart-card interface Multi-processor function On-chip baud rate generator allows selection of the desired bit rate Choice of LSB-first or MSB-first transfer Average transfer rate clock can be input from TMR timers for SCI5, SCI6, and SCI12 Start-bit detection: Level or edge detection is selectable. Simple I^2C Simple SPI 9-bit transfer mode Bit rate modulation Double-speed mode Event linking by the ELC (only on channel 5) • SCIh (The following functions are added to SCIg) Supports the serial communications protocol, which contains the start frame and information frame Supports the LIN format
	Serial communications interface with FIFO (SCIFA)	• 4 channels • Methods of transfer: Asynchronous and clock synchronous • Desired bit rates can be selected from the internal baud rate generators. • LSB or MSB first is selectable. • Both the transmission and reception sections are equipped with 16-byte FIFO buffers, allowing continuous transmission and reception. • Bit rate modulation • Double-speed mode

Table 1.4 Pin Functions (6/8)

Classifications	Pin Name	I/O	Description
USB 2.0 host/function module	VCC_USB, VCC_USBA	Input	Power supply pins
	VSS_USB, VSS1_USBA, VSS2_USBA	Input	Ground pins
	AVCC_USBA	Input	USBA analog power supply pin
	AVSS_USBA	Input	USBA analog ground pin. Short this pin with the PVSS_USBA pin.
	PVSS_USBA	Input	USBA PLL circuit ground pin. Short this pin with the AVSS_USBA pin.
	USBA_RREF	I/O	USBA reference current supply pin. Connect 2.2 kΩ (±1%) to the AVSS_USBA pin.
	USB0_DP, USBA_DP	I/O	Input or output USB transceiver D+ data.
	USB0_DM, USBA_DM	I/O	Input or output USB transceiver D- data.
	USB0_EXICEN, USBA_EXICEN	Output	Connect to the OTG power IC.
	USB0_ID, USBA_ID	Input	Connect to the OTG power IC.
	USB0_VBUSEN USBA_VBUSEN	Output	USB VBUS power enable pins
	USB0_OVRCURA/ USB0_OVRCURB, USBA_OVRCURA/ USBA_OVRCURB	Input	USB overcurrent pins
	USB0_VBUS, USBA_VBUS	Input	USB cable connection/disconnection detection input pins
CAN module	CRX0, CRX1-DS, CRX2	Input	Input pins
	CTX0 to CTX2	Output	Output pins
Serial peripheral interface	RSPCKA-A/RSPCKA-B	I/O	Clock input/output pin
	MOSIA-A/MOSIA-B	I/O	Inputs or outputs data output from the master
	MISOA-A/MISOA-B	I/O	Inputs or outputs data output from the slave
	SSLA0-A/SSLA0-B	I/O	Input or output pin for slave selection
	SSLA1-A/SSLA1-B to SSLA3-A/SSLA3-B	Output	Output pin for slave selection
Quad serial peripheral interface	QSPCLK-A/-B	Output	QSPI clock output pin
	QSSL-A/-B	Output	QSPI slave output pin
	QMO-A/-B, QIO0-A/-B	I/O	Master transmit data/data 0
	QMI-A/-B, QIO1-A/-B	I/O	Master input data/data 1
	QIO2-A/-B, QIO3-A/-B	I/O	Data 2, data 3
Serial sound interface	SSISCK0, SSISCK1	I/O	SSI serial bit clock pins
	SSIWS0, SSIWS1	I/O	Word select pins
	SSITXD0, SSITXD1	Output	Serial data output pins
	SSIRXD0, SSIRXD1	Input	Serial data input pins
	SSIDATA0, SSIDATA1	I/O	Serial data input/output pins
	AUDIO_MCLK	Input	Master clock pin for audio

Table 1.4 Pin Functions (8/8)

Classifications	Pin Name	I/O	Description
I/O ports	P00 to P03, P05, P07	I/O	6-bit input/output pins
	P10 to P17	I/O	8-bit input/output pins
	P20 to P27	I/O	8-bit input/output pins
	P30 to P37	I/O	8-bit input/output pins (P35: input pin)
	P40 to P47	I/O	8-bit input/output pins
	P50 to P56	I/O	7-bit input/output pins (176-pin devices have only P50 to P53)
	P60 to P67	I/O	8-bit input/output pins
	P70 to P77	I/O	8-bit input/output pins
	P80 to P83, P86, P87	I/O	6-bit input/output pins
	P90 to P97	I/O	8-bit input/output pins
	PA0 to PA7	I/O	8-bit input/output pins
	PB0 to PB7	I/O	8-bit input/output pins
	PC0 to PC7	I/O	8-bit input/output pins
	PD0 to PD7	I/O	8-bit input/output pins
	PE0 to PE7	I/O	8-bit input/output pins
	PF0 to PF5	I/O	6-bit input/output pins
	PG0 to PG7	I/O	8-bit input/output pins
	PJ3, PJ5	I/O	2-bit input/output pins

Note: Note the following regarding pin names. For details, see section 1.5, Pin Assignments.

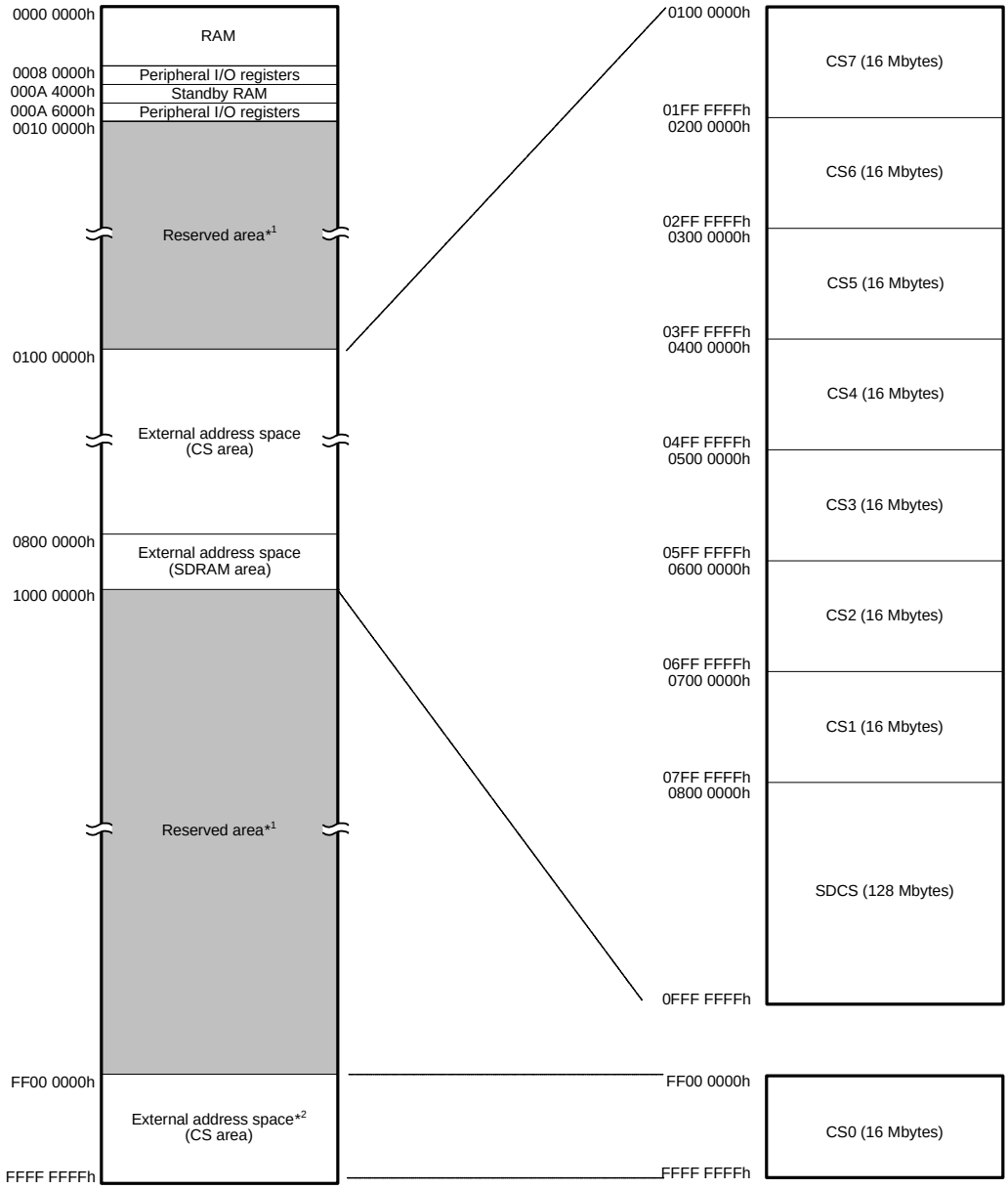
- We recommend using pins that have a letter (“-A”, “-B”, etc.) to indicate group membership appended to their names as groups. For the RSPI, QSPI, SDHI, and MMC interfaces, the AC portion of the electrical characteristics is measured for each group.
- Pins that have "-DS" appended to their names can be used as triggers for release from deep software standby.
- RIIC pin functions that have [FM+] appended to their names support fast-mode plus.

Table 1.6 List of Pin and Pin Functions (176-Pin LFQFP) (1/7)

Pin Number 176-Pin LFQFP	Power Supply Clock System Control	I/O Port	Bus EXDMAC SDRAMC	Timer (MTU, GPT, TPU, TMR, PPG, RTC, CMTW, POE, CAC)	Communication (ETHERC, SCIg, SCIh, RSPI, RIIC, CAN, USB, SSI)	Memory Interface Camera Interface (QSPI, SDHI, MMCIF, PDC)	Interrupt	S12ADC, R12DA
1	AVSS0							
2		P05					IRQ13	DA1
3	AVCC1							
4		P03					IRQ11	DA0
5	AVSS1							
6		P02		TMCI1	SCK6		IRQ10	AN120
7		P01		TMCI0	RXD6/SMISO6/ SSCL6		IRQ9	AN119
8		P00		TMRI0	TXD6/SMOSI6/ SSDA6		IRQ8	AN118
9		PF5					IRQ4	
10	EMLE							
11		PJ5		POE8#	CTS2#/RTS2#/SS2#			
12	VSS							
13		PJ3	EDACK1	MTIOC3C	ET0_EXOUT/ CTS6#/RTS6#/ CTS0#/RTS0#/ SS6#/SS0#			
14	VCL							
15	VBATT							
16	NC							
17	TRST#	PF4						
18	MD/FINED							
19	XCIN							
20	XCOUT							
21	RES#							
22	XTAL	P37						
23	VSS							
24	EXTAL	P36						
25	VCC							
26	UPSEL	P35					NMI	
27		P34		MTIOC0A/TMCI3/ PO12/POE10#	SCK6/SCK0/ ET0_LINKSTA		IRQ4	
28		P33	EDREQ1	MTIOC0D/TIOCD0/ TMRI3/PO11/POE4#/ POE11#	RXD6/RXD0/ SMISO6/ SMISO0/SSCL6/ SSCL0/CRX0	PCKO	IRQ3-DS	
29		P32		MTIOC0C/TIOCC0/ TMO3/PO10/ RTCOUT/RTCIC2/ POE0#/POE10#	TXD6/TXD0/ SMOSI6/SMOSI0/ SSDA6/SSDA0/ CTX0/ USB0_VBUSEN	VSYNC	IRQ2-DS	
30	TMS	PF3						
31	TDI	PF2			RXD1/SMISO1/ SSCL1			
32		P31		MTIOC4D/TMCI2/ PO9/RTCIC1	CTS1#/RTS1#/ SS1#/ET1_MDC		IRQ1-DS	
33		P30		MTIOC4B/TMRI3/ PO8/RTCIC0/POE8#	RXD1/SMISO1/ SSCL1/ ET1_MDIO		IRQ0-DS	
34	TCK	PF1			SCK1			
35	TDO	PF0			TXD1/SMOSI1/ SSDA1			

3.2 External Address Space

The external address space is divided into CS areas (CS0 to CS7) and SDRAM area (SDCS). The CS areas are divided into up to eight areas (CS0 to CS7), each corresponding to the CSn# signal output from a CSn# (n = 0 to 7) pin.
Figure 3.2 shows the address ranges corresponding to the individual CS areas (CS0 to CS7) and SDRAM areas (SDCS) in on-chip ROM disabled extended mode.



Note 1. Reserved areas should not be accessed.
Note 2. The CS0 area is disabled in on-chip ROM enabled extended mode.
In this mode, the address space for addresses above 1000 0000h is as shown in figure on this section, Memory Map in Each Operating Mode.

Figure 3.2 Correspondence between External Address Spaces and CS Areas (In On-Chip ROM Disabled Extended Mode)

Table 4.1 List of I/O Registers (Address Order) (22 / 67)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access Cycles		Related Function
						ICLK ≥ PCLK	ICLK < PCLK	
0008 A009h	SCI0	I²C Mode Register 1	SIMR1	8	8	2, 3 PCLKB	2 ICLK	SCIg, SCIh
0008 A00Ah	SCI0	I²C Mode Register 2	SIMR2	8	8	2, 3 PCLKB	2 ICLK	SCIg, SCIh
0008 A00Bh	SCI0	I²C Mode Register 3	SIMR3	8	8	2, 3 PCLKB	2 ICLK	SCIg, SCIh
0008 A00Ch	SCI0	I²C Status Register	SISR	8	8	2, 3 PCLKB	2 ICLK	SCIg, SCIh
0008 A00Dh	SCI0	SPI Mode Register	SPMR	8	8	2, 3 PCLKB	2 ICLK	SCIg, SCIh
0008 A00Eh	SCI0	Transmit Data Register H	TDRH	8	8	2, 3 PCLKB	2 ICLK	SCIg, SCIh
0008 A00Fh	SCI0	Transmit Data Register L	TDRL	8	8	2, 3 PCLKB	2 ICLK	SCIg, SCIh
0008 A00Eh	SCI0	Transmit Data Register HL	TDRHL	16	16	4, 5 PCLKB	2 ICLK	SCIg, SCIh
0008 A010h	SCI0	Receive Data Register H	RDRH	8	8	2, 3 PCLKB	2 ICLK	SCIg, SCIh
0008 A011h	SCI0	Receive Data Register L	RDRL	8	8	2, 3 PCLKB	2 ICLK	SCIg, SCIh
0008 A010h	SCI0	Receive Data Register HL	RDRHL	16	16	4, 5 PCLKB	2 ICLK	SCIg, SCIh
0008 A012h	SCI0	Modulation Duty Register	MDDR	8	8	2, 3 PCLKB	2 ICLK	SCIg, SCIh
0008 A020h	SCI1	Serial Mode Register	SMR	8	8	2, 3 PCLKB	2 ICLK	SCIg, SCIh
0008 A021h	SCI1	Bit Rate Register	BRR	8	8	2, 3 PCLKB	2 ICLK	SCIg, SCIh
0008 A022h	SCI1	Serial Control Register	SCR	8	8	2, 3 PCLKB	2 ICLK	SCIg, SCIh
0008 A023h	SCI1	Transmit Data Register	TDR	8	8	2, 3 PCLKB	2 ICLK	SCIg, SCIh
0008 A024h	SCI1	Serial Status Register	SSR	8	8	2, 3 PCLKB	2 ICLK	SCIg, SCIh
0008 A025h	SCI1	Receive Data Register	RDR	8	8	2, 3 PCLKB	2 ICLK	SCIg, SCIh
0008 A026h	SMCI1	Smart Card Mode Register	SCMR	8	8	2, 3 PCLKB	2 ICLK	SCIg, SCIh
0008 A027h	SCI1	Serial Extended Mode Register	SEMR	8	8	2, 3 PCLKB	2 ICLK	SCIg, SCIh
0008 A028h	SCI1	Noise Filter Setting Register	SNFR	8	8	2, 3 PCLKB	2 ICLK	SCIg, SCIh
0008 A029h	SCI1	I²C Mode Register 1	SIMR1	8	8	2, 3 PCLKB	2 ICLK	SCIg, SCIh
0008 A02Ah	SCI1	I²C Mode Register 2	SIMR2	8	8	2, 3 PCLKB	2 ICLK	SCIg, SCIh
0008 A02Bh	SCI1	I²C Mode Register 3	SIMR3	8	8	2, 3 PCLKB	2 ICLK	SCIg, SCIh
0008 A02Ch	SCI1	I²C Status Register	SISR	8	8	2, 3 PCLKB	2 ICLK	SCIg, SCIh
0008 A02Dh	SCI1	SPI Mode Register	SPMR	8	8	2, 3 PCLKB	2 ICLK	SCIg, SCIh
0008 A02Eh	SCI1	Transmit Data Register H	TDRH	8	8	2, 3 PCLKB	2 ICLK	SCIg, SCIh
0008 A02Fh	SCI1	Transmit Data Register L	TDRL	8	8	2, 3 PCLKB	2 ICLK	SCIg, SCIh
0008 A02Eh	SCI1	Transmit Data Register HL	TDRHL	16	16	4, 5 PCLKB	2 ICLK	SCIg, SCIh
0008 A030h	SCI1	Receive Data Register H	RDRH	8	8	2, 3 PCLKB	2 ICLK	SCIg, SCIh
0008 A031h	SCI1	Receive Data Register L	RDRL	8	8	2, 3 PCLKB	2 ICLK	SCIg, SCIh

Table 4.1 List of I/O Registers (Address Order) (28 / 67)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access Cycles		Related Function
						ICLK ≥ PCLK	ICLK < PCLK	
0008 B004h	CAC	CAC Status Register	CASTR	8	8	2, 3 PCLKB	2 ICLK	CAC
0008 B006h	CAC	CAC Upper-Limit Value Setting Register	CAULVR	16	16	2, 3 PCLKB	2 ICLK	CAC
0008 B008h	CAC	CAC Lower-Limit Value Setting Register	CALLVR	16	16	2, 3 PCLKB	2 ICLK	CAC
0008 B00Ah	CAC	CAC Counter Buffer Register	CACNTBR	16	16	2, 3 PCLKB	2 ICLK	CAC
0008 B080h	DOC	DOC Control Register	DOCR	8	8	2, 3 PCLKB	2 ICLK	DOC
0008 B082h	DOC	DOC Data Input Register	DODIR	16	16	2, 3 PCLKB	2 ICLK	DOC
0008 B084h	DOC	DOC Data Setting Register	DODSR	16	16	2, 3 PCLKB	2 ICLK	DOC
0008 B100h	ELC	Event Link Control Register	ELCR	8	8	2, 3 PCLKB	2 ICLK	ELC
0008 B101h	ELC	Event Link Setting Register 0	ELSR0	8	8	2, 3 PCLKB	2 ICLK	ELC
0008 B104h	ELC	Event Link Setting Register 3	ELSR3	8	8	2, 3 PCLKB	2 ICLK	ELC
0008 B105h	ELC	Event Link Setting Register 4	ELSR4	8	8	2, 3 PCLKB	2 ICLK	ELC
0008 B108h	ELC	Event Link Setting Register 7	ELSR7	8	8	2, 3 PCLKB	2 ICLK	ELC
0008 B10Bh	ELC	Event Link Setting Register 10	ELSR10	8	8	2, 3 PCLKB	2 ICLK	ELC
0008 B10Ch	ELC	Event Link Setting Register 11	ELSR11	8	8	2, 3 PCLKB	2 ICLK	ELC
0008 B10Dh	ELC	Event Link Setting Register 12	ELSR12	8	8	2, 3 PCLKB	2 ICLK	ELC
0008 B10Eh	ELC	Event Link Setting Register 13	ELSR13	8	8	2, 3 PCLKB	2 ICLK	ELC
0008 B110h	ELC	Event Link Setting Register 15	ELSR15	8	8	2, 3 PCLKB	2 ICLK	ELC
0008 B111h	ELC	Event Link Setting Register 16	ELSR16	8	8	2, 3 PCLKB	2 ICLK	ELC
0008 B113h	ELC	Event Link Setting Register 18	ELSR18	8	8	2, 3 PCLKB	2 ICLK	ELC
0008 B114h	ELC	Event Link Setting Register 19	ELSR19	8	8	2, 3 PCLKB	2 ICLK	ELC
0008 B115h	ELC	Event Link Setting Register 20	ELSR20	8	8	2, 3 PCLKB	2 ICLK	ELC
0008 B116h	ELC	Event Link Setting Register 21	ELSR21	8	8	2, 3 PCLKB	2 ICLK	ELC
0008 B117h	ELC	Event Link Setting Register 22	ELSR22	8	8	2, 3 PCLKB	2 ICLK	ELC
0008 B118h	ELC	Event Link Setting Register 23	ELSR23	8	8	2, 3 PCLKB	2 ICLK	ELC
0008 B119h	ELC	Event Link Setting Register 24	ELSR24	8	8	2, 3 PCLKB	2 ICLK	ELC
0008 B11Ah	ELC	Event Link Setting Register 25	ELSR25	8	8	2, 3 PCLKB	2 ICLK	ELC
0008 B11Bh	ELC	Event Link Setting Register 26	ELSR26	8	8	2, 3 PCLKB	2 ICLK	ELC
0008 B11Ch	ELC	Event Link Setting Register 27	ELSR27	8	8	2, 3 PCLKB	2 ICLK	ELC
0008 B11Dh	ELC	Event Link Setting Register 28	ELSR28	8	8	2, 3 PCLKB	2 ICLK	ELC
0008 B11Fh	ELC	Event Link Option Setting Register A	ELOPA	8	8	2, 3 PCLKB	2 ICLK	ELC
0008 B120h	ELC	Event Link Option Setting Register B	ELOPB	8	8	2, 3 PCLKB	2 ICLK	ELC
0008 B121h	ELC	Event Link Option Setting Register C	ELOPC	8	8	2, 3 PCLKB	2 ICLK	ELC
0008 B122h	ELC	Event Link Option Setting Register D	ELOPD	8	8	2, 3 PCLKB	2 ICLK	ELC
0008 B123h	ELC	Port Group Setting Register 1	PGR1	8	8	2, 3 PCLKB	2 ICLK	ELC
0008 B124h	ELC	Port Group Setting Register 2	PGR2	8	8	2, 3 PCLKB	2 ICLK	ELC
0008 B125h	ELC	Port Group Control Register 1	PGC1	8	8	2, 3 PCLKB	2 ICLK	ELC
0008 B126h	ELC	Port Group Control Register 2	PGC2	8	8	2, 3 PCLKB	2 ICLK	ELC
0008 B127h	ELC	Port Buffer Register 1	PDBF1	8	8	2, 3 PCLKB	2 ICLK	ELC
0008 B128h	ELC	Port Buffer Register 2	PDBF2	8	8	2, 3 PCLKB	2 ICLK	ELC
0008 B129h	ELC	Event Link Port Setting Register 0	PEL0	8	8	2, 3 PCLKB	2 ICLK	ELC
0008 B12Ah	ELC	Event Link Port Setting Register 1	PEL1	8	8	2, 3 PCLKB	2 ICLK	ELC
0008 B12Bh	ELC	Event Link Port Setting Register 2	PEL2	8	8	2, 3 PCLKB	2 ICLK	ELC
0008 B12Ch	ELC	Event Link Port Setting Register 3	PEL3	8	8	2, 3 PCLKB	2 ICLK	ELC
0008 B12Dh	ELC	Event Link Software Event Generation Register	ELSEGR	8	8	2, 3 PCLKB	2 ICLK	ELC
0008 B131h	ELC	Event Link Setting Register 33	ELSR33	8	8	2, 3 PCLKB	2 ICLK	ELC
0008 B133h	ELC	Event Link Setting Register 35	ELSR35	8	8	2, 3 PCLKB	2 ICLK	ELC
0008 B134h	ELC	Event Link Setting Register 36	ELSR36	8	8	2, 3 PCLKB	2 ICLK	ELC
0008 B135h	ELC	Event Link Setting Register 37	ELSR37	8	8	2, 3 PCLKB	2 ICLK	ELC
0008 B136h	ELC	Event Link Setting Register 38	ELSR38	8	8	2, 3 PCLKB	2 ICLK	ELC
0008 B139h	ELC	Event Link Setting Register 41	ELSR41	8	8	2, 3 PCLKB	2 ICLK	ELC

Table 4.1 List of I/O Registers (Address Order) (48 / 67)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access Cycles		Related Function
						ICLK ≥ PCLK	ICLK < PCLK	
000C 0440h	PTPEDMAC	Missed-Frame Counter Register	RMFCR	32	32	4, 5 PCLKA	2, 3 ICLK	EDMACa
000C 0448h	PTPEDMAC	Transmit FIFO Threshold Register	TFTR	32	32	4, 5 PCLKA	2, 3 ICLK	EDMACa
000C 0450h	PTPEDMAC	FIFO Depth Register	FDR	32	32	4, 5 PCLKA	2, 3 ICLK	EDMACa
000C 0458h	PTPEDMAC	Receive Method Control Register	RMCR	32	32	4, 5 PCLKA	2, 3 ICLK	EDMACa
000C 0464h	PTPEDMAC	Transmit FIFO Underflow Counter	TFUCR	32	32	4, 5 PCLKA	2, 3 ICLK	EDMACa
000C 0468h	PTPEDMAC	Receive FIFO Overflow Counter	RFOCR	32	32	4, 5 PCLKA	2, 3 ICLK	EDMACa
000C 0470h	PTPEDMAC	Flow Control Start FIFO Threshold Setting Register	FCFTR	32	32	4, 5 PCLKA	2, 3 ICLK	EDMACa
000C 0478h	PTPEDMAC	Receive Data Padding Insert Register	RPADIR	32	32	4, 5 PCLKA	2, 3 ICLK	EDMACa
000C 047Ch	PTPEDMAC	Transmit Interrupt Setting Register	TRIMD	32	32	4, 5 PCLKA	2, 3 ICLK	EDMACa
000C 04C8h	PTPEDMAC	Receive Buffer Write Address Register	RBWAR	32	32	4, 5 PCLKA	2, 3 ICLK	EDMACa
000C 04CCh	PTPEDMAC	Receive Descriptor Fetch Address Register	RDFAR	32	32	4, 5 PCLKA	2, 3 ICLK	EDMACa
000C 04D4h	PTPEDMAC	Transmit Buffer Read Address Register	TBRAR	32	32	4, 5 PCLKA	2, 3 ICLK	EDMACa
000C 04D8h	PTPEDMAC	Transmit Descriptor Fetch Address Register	TDFAR	32	32	4, 5 PCLKA	2, 3 ICLK	EDMACa
000C 0500h	EPTPC	PTP Reset Register	PTRSTR	32	32	3, 4 PCLKA	2, 3 ICLK	EPTPC
000C 0504h	EPTPC	STCA Clock Select Register	STCSELR	32	32	3, 4 PCLKA	2, 3 ICLK	EPTPC
000C 1200h	MTU3	Timer Control Register	TCR	8	8	5, 6 PCLKA	2, 3 ICLK	MTU3a
000C 1201h	MTU4	Timer Control Register	TCR	8	8	5, 6 PCLKA	2, 3 ICLK	MTU3a
000C 1202h	MTU3	Timer Mode Register 1	TMDR1	8	8	5, 6 PCLKA	2, 3 ICLK	MTU3a
000C 1203h	MTU4	Timer Mode Register 1	TMDR1	8	8	5, 6 PCLKA	2, 3 ICLK	MTU3a
000C 1204h	MTU3	Timer I/O Control Register H	TIORH	8	8	5, 6 PCLKA	2, 3 ICLK	MTU3a
000C 1205h	MTU3	Timer I/O Control Register L	TIORL	8	8	5, 6 PCLKA	2, 3 ICLK	MTU3a
000C 1206h	MTU4	Timer I/O Control Register H	TIORH	8	8	5, 6 PCLKA	2, 3 ICLK	MTU3a
000C 1207h	MTU4	Timer I/O Control Register L	TIORL	8	8	5, 6 PCLKA	2, 3 ICLK	MTU3a
000C 1208h	MTU3	Timer Interrupt Enable Register	TIER	8	8	5, 6 PCLKA	2, 3 ICLK	MTU3a
000C 1209h	MTU4	Timer Interrupt Enable Register	TIER	8	8	5, 6 PCLKA	2, 3 ICLK	MTU3a
000C 120Ah	MTU	Timer Output Master Enable Register A	TOERA	8	8	5, 6 PCLKA	2, 3 ICLK	MTU3a
000C 120Dh	MTU	Timer Gate Control Register A	TGCRA	8	8	5, 6 PCLKA	2, 3 ICLK	MTU3a
000C 120Eh	MTU	Timer Output Control Register 1A	TOCR1A	8	8	5, 6 PCLKA	2, 3 ICLK	MTU3a
000C 120Fh	MTU	Timer Output Control Register 2A	TOCR2A	8	8	5, 6 PCLKA	2, 3 ICLK	MTU3a
000C 1210h	MTU3	Timer Counter	TCNT	16	16	5, 6 PCLKA	2, 3 ICLK	MTU3a
000C 1212h	MTU4	Timer Counter	TCNT	16	16	5, 6 PCLKA	2, 3 ICLK	MTU3a
000C 1214h	MTU	Timer Cycle Data Register A	TCDRA	16	16	5, 6 PCLKA	2, 3 ICLK	MTU3a
000C 1216h	MTU	Timer Dead Time Data Register A	TDDRA	16	16	5, 6 PCLKA	2, 3 ICLK	MTU3a
000C 1218h	MTU3	Timer General Register A	TGRA	16	16	5, 6 PCLKA	2, 3 ICLK	MTU3a
000C 121Ah	MTU3	Timer General Register B	TGRB	16	16	5, 6 PCLKA	2, 3 ICLK	MTU3a
000C 121Ch	MTU4	Timer General Register A	TGRA	16	16	5, 6 PCLKA	2, 3 ICLK	MTU3a
000C 121Eh	MTU4	Timer General Register B	TGRB	16	16	5, 6 PCLKA	2, 3 ICLK	MTU3a
000C 1220h	MTU	Timer Subcounter A	TCNTSA	16	16	5, 6 PCLKA	2, 3 ICLK	MTU3a
000C 1222h	MTU	Timer Cycle Buffer Register A	TCBRA	16	16	5, 6 PCLKA	2, 3 ICLK	MTU3a
000C 1224h	MTU3	Timer General Register C	TGRC	16	16	5, 6 PCLKA	2, 3 ICLK	MTU3a
000C 1226h	MTU3	Timer General Register D	TGRD	16	16	5, 6 PCLKA	2, 3 ICLK	MTU3a
000C 1228h	MTU4	Timer General Register C	TGRC	16	16	5, 6 PCLKA	2, 3 ICLK	MTU3a

Table 4.1 List of I/O Registers (Address Order) (56 / 67)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access Cycles		Related Function
						ICLK ≥ PCLK	ICLK < PCLK	
000C 4138h	EPTPC	Negative Gradient Limit Register	MLIMITRM	32	32	8 to 43 PCLKA	2 to 22 ICLK	EPTPC
000C 413Ch	EPTPC	Negative Gradient Limit Register	MLIMITRL	32	32	8 to 43 PCLKA	2 to 22 ICLK	EPTPC
000C 4140h	EPTPC	Statistical Information Retention Control Register	GETINFOR	32	32	8 to 43 PCLKA	2 to 22 ICLK	EPTPC
000C 4170h	EPTPC	Local Time Counter	LCCVRU	32	32	8 to 43 PCLKA	2 to 22 ICLK	EPTPC
000C 4174h	EPTPC	Local Time Counter	LCCVRM	32	32	8 to 43 PCLKA	2 to 22 ICLK	EPTPC
000C 4178h	EPTPC	Local Time Counter	LCCVRL	32	32	8 to 43 PCLKA	2 to 22 ICLK	EPTPC
000C 4210h	EPTPC	Positive Gradient Worst 10 Value Register	PW10VRU	32	32	8 to 43 PCLKA	2 to 22 ICLK	EPTPC
000C 4214h	EPTPC	Positive Gradient Worst 10 Value Register	PW10VRM	32	32	8 to 43 PCLKA	2 to 22 ICLK	EPTPC
000C 4218h	EPTPC	Positive Gradient Worst 10 Value Register	PW10VRL	32	32	8 to 43 PCLKA	2 to 22 ICLK	EPTPC
000C 42D0h	EPTPC	Negative Gradient Worst 10 Value Register	MW10RU	32	32	8 to 43 PCLKA	2 to 22 ICLK	EPTPC
000C 42D4h	EPTPC	Negative Gradient Worst 10 Value Register	MW10RM	32	32	8 to 43 PCLKA	2 to 22 ICLK	EPTPC
000C 42D8h	EPTPC	Negative Gradient Worst 10 Value Register	MW10RL	32	32	8 to 43 PCLKA	2 to 22 ICLK	EPTPC
000C 4300h	EPTPC	Timer Start Time Setting Register	TMSTTRU0	32	32	8 to 43 PCLKA	2 to 22 ICLK	EPTPC
000C 4304h	EPTPC	Timer Start Time Setting Register	TMSTTRL0	32	32	8 to 43 PCLKA	2 to 22 ICLK	EPTPC
000C 4308h	EPTPC	Timer Cycle Setting Register 0	TMCYCR0	32	32	8 to 43 PCLKA	2 to 22 ICLK	EPTPC
000C 430Ch	EPTPC	Timer Pulse Width Setting Register 0	TMPLSR0	32	32	8 to 43 PCLKA	2 to 22 ICLK	EPTPC
000C 4310h	EPTPC	Timer Start Time Setting Register	TMSTTRU1	32	32	8 to 43 PCLKA	2 to 22 ICLK	EPTPC
000C 4314h	EPTPC	Timer Start Time Setting Register	TMSTTRL1	32	32	8 to 43 PCLKA	2 to 22 ICLK	EPTPC
000C 4318h	EPTPC	Timer Cycle Setting Register 1	TMCYCR1	32	32	8 to 43 PCLKA	2 to 22 ICLK	EPTPC
000C 431Ch	EPTPC	Timer Pulse Width Setting Register 1	TMPLSR1	32	32	8 to 43 PCLKA	2 to 22 ICLK	EPTPC
000C 4320h	EPTPC	Timer Start Time Setting Register	TMSTTRU2	32	32	8 to 43 PCLKA	2 to 22 ICLK	EPTPC
000C 4324h	EPTPC	Timer Start Time Setting Register	TMSTTRL2	32	32	8 to 43 PCLKA	2 to 22 ICLK	EPTPC
000C 4328h	EPTPC	Timer Cycle Setting Register 2	TMCYCR2	32	32	8 to 43 PCLKA	2 to 22 ICLK	EPTPC
000C 432Ch	EPTPC	Timer Pulse Width Setting Register 2	TMPLSR2	32	32	8 to 43 PCLKA	2 to 22 ICLK	EPTPC
000C 4330h	EPTPC	Timer Start Time Setting Register	TMSTTRU3	32	32	8 to 43 PCLKA	2 to 22 ICLK	EPTPC
000C 4334h	EPTPC	Timer Start Time Setting Register	TMSTTRL3	32	32	8 to 43 PCLKA	2 to 22 ICLK	EPTPC
000C 4338h	EPTPC	Timer Cycle Setting Register 3	TMCYCR3	32	32	8 to 43 PCLKA	2 to 22 ICLK	EPTPC
000C 433Ch	EPTPC	Timer Pulse Width Setting Register 3	TMPLSR3	32	32	8 to 43 PCLKA	2 to 22 ICLK	EPTPC
000C 4340h	EPTPC	Timer Start Time Setting Register	TMSTTRU4	32	32	8 to 43 PCLKA	2 to 22 ICLK	EPTPC
000C 4344h	EPTPC	Timer Start Time Setting Register	TMSTTRL4	32	32	8 to 43 PCLKA	2 to 22 ICLK	EPTPC
000C 4348h	EPTPC	Timer Cycle Setting Register 4	TMCYCR4	32	32	8 to 43 PCLKA	2 to 22 ICLK	EPTPC
000C 434Ch	EPTPC	Timer Pulse Width Setting Register 4	TMPLSR4	32	32	8 to 43 PCLKA	2 to 22 ICLK	EPTPC
000C 4350h	EPTPC	Timer Start Time Setting Register	TMSTTRU5	32	32	8 to 43 PCLKA	2 to 22 ICLK	EPTPC
000C 4354h	EPTPC	Timer Start Time Setting Register	TMSTTRL5	32	32	8 to 43 PCLKA	2 to 22 ICLK	EPTPC
000C 4358h	EPTPC	Timer Cycle Setting Register 5	TMCYCR5	32	32	8 to 43 PCLKA	2 to 22 ICLK	EPTPC
000C 435Ch	EPTPC	Timer Pulse Width Setting Register 5	TMPLSR5	32	32	8 to 43 PCLKA	2 to 22 ICLK	EPTPC
000C 437Ch	EPTPC	Timer Start Register	TMSTARTR	32	32	8 to 43 PCLKA	2 to 22 ICLK	EPTPC
000C 4400h	EPTPC	PRC-TC Status Register	PRSR	32	32	9, 10 PCLKA	2 to 5 ICLK	EPTPC
000C 4404h	EPTPC	PRC-TC Status Notification Permission Register	PRIPR	32	32	9, 10 PCLKA	2 to 5 ICLK	EPTPC
000C 4410h	EPTPC	Channel 0 Local MAC Address Register	PRMACRU0	32	32	9, 10 PCLKA	2 to 5 ICLK	EPTPC
000C 4414h	EPTPC	Channel 0 Local MAC Address Register	PRMACRL0	32	32	9, 10 PCLKA	2 to 5 ICLK	EPTPC
000C 4418h	EPTPC	Channel 1 Local MAC Address Register	PRMACRU1	32	32	9, 10 PCLKA	2 to 5 ICLK	EPTPC
000C 441Ch	EPTPC	Channel 1 Local MAC Address Register	PRMACRL1	32	32	9, 10 PCLKA	2 to 5 ICLK	EPTPC
000C 4420h	EPTPC	Packet Transmission Control Register	TRNDISR	32	32	9, 10 PCLKA	2 to 5 ICLK	EPTPC
000C 4430h	EPTPC	Relay Mode Register	TRNMR	32	32	9, 10 PCLKA	2 to 5 ICLK	EPTPC
000C 4434h	EPTPC	Cut-Through Transfer Start Threshold Register	TRNCTTDR	32	32	9, 10 PCLKA	2 to 5 ICLK	EPTPC
000C 4800h	EPTPC 0	SYNFP Status Register	SYSR	32	32	9 to 211 PCLKA	2 to 106 ICLK	EPTPC
000C 4804h	EPTPC 0	SYNFP Status Notification Permission Register	SYIPR	32	32	9 to 211 PCLKA	2 to 106 ICLK	EPTPC

Table 5.3 DC Characteristics (2)

Conditions: VCC = AVCC0 = AVCC1 = VCC_USB = V_{BATT} = 2.7 to 3.6 V, 2.7 ≤ VREFH0 ≤ AVCC0,
VCC_USBA = AVCC_USBA = 3.0 to 3.6 V,
VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = VSS1_USBA = VSS2_USBA = PVSS_USBA = AVSS_USBA = 0 V,
$T_a = T_{opr}$

Item		Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Output high voltage	All output pins	V_{OH}	VCC – 0.5	—	—	V	I_{OH} = –1 mA
Output low voltage	All output pins (except for RIIC pins and ETHERC output pin)	V_{OL}	—	—	0.5	V	I_{OL} = 1.0 mA
	RIIC output pin		—	—	0.4		I_{OL} = 3.0 mA
			—	—	0.6		I_{OL} = 6.0 mA
	RIIC output pin (only P12 and P13 in channel 0)	V_{OL}	—	—	0.4	V	I_{OL} = 15.0 mA (ICFER.FMPE = 1)
			—	0.4	—		I_{OL} = 20.0 mA (ICFER.FMPE = 1)
	ETHERC output pin	V_{OL}	—	—	0.4	V	I_{OL} = 1.0 mA
Input leakage current	RES#, MD pin, EMLE*1, BSCANP*1, NMI	$\lvert I_{in} \rvert$	—	—	1.0	μA	V_{in} = 0 V V_{in} = VCC
Three-state leakage current (off state)	Other than ports for 5 V tolerant	$\lvert I_{TSI} \rvert$	—	—	1.0	μA	V_{in} = 0 V V_{in} = VCC
	Ports for 5 V tolerant		—	—	5.0		V_{in} = 0 V V_{in} = 5.5 V
Input pull-up MOS current	Ports 0 to 2, 30 to 34, 36, 37, 4 to G, J3, J5	I_p	–300	—	–10	μA	VCC = 2.7 to 3.6 V V_{in} = 0 V
Input pull-down MOS current	EMLE, BSCANP	I_p	10	—	300	μA	V_{in} = VCC
Input capacitance	All input pins (except for ports 03, 05, 12, 13, 16, 17, EMLE, BSCANP, USB0_DP, USB0_DM, USBA_DP, and USBA_DM)	C_{in}	—	—	8	pF	Vbias = 0 V Vamp = 20 mV f = 1 MHz T_a = 25°C
	Ports 03, 05, 12, 13, 16, 17, EMLE, BSCANP, USB0_DP, USB0_DM, USBA_DP, and USBA_DM		—	—	16		

Note 1. The input leakage current value at the EMLE and BSCANP pins are only when V_{in} = 0 V.

Table 5.4 DC Characteristics (3)

Conditions: VCC = AVCC0 = AVCC1 = VREFH0 = VCC_USB = 2.7 to 3.6 V, 2.7 ≤ VREFH0 ≤ AVCC0,
VCC_USBA = AVCC_USBA = 3.0 to 3.6 V,
VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = VSS1_USBA = VSS2_USBA = PVSS_USBA = AVSS_USBA = 0 V,
$T_a = T_{opr}$

Item				Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Supply current*1	High-speed operating mode	Max.*2		I_{CC}*3	—	—	110	mA	ICLK = 120 MHz PCLKA = 120 MHz PCLKB = 60 MHz PCLKC = 60 MHz PCLKD = 60 MHz FCLK = 60 MHz BCLK = 120 MHz BCLK pin = 60 MHz
		Normal	Peripheral function clock signal supplied*4		—	39	—		
			Peripheral function clock signal stopped*4		—	16	—		
		Coremark	Peripheral function clock signal stopped*4		—	21	—		
		Sleep mode: Supply of the clock signal to peripheral modules is stopped*4				32	61		
		All-module-clock-stop mode (reference value)			—	10	28		
		Increased by BGO operation *5	Reading from the code flash memory while the data flash memory is being programmed		—	7	—		
			Reading from the code flash memory while the code flash memory is being programmed		—	10	—		
	Low-speed operating mode 1: Supply of the clock signal to peripheral modules is stopped*4				—	3	—		All clocks 1 MHz
	Low-speed operating mode 2: Supply of the clock signal to peripheral modules is stopped*4				—	1.2	—		All clocks 32.768 kHz
	Software standby mode				—	0.7	10		
	Deep software standby mode	Power supplied to standby RAM and USB resume detecting unit (USB0 only)			—	22	63	μA	
		Power not supplied to standby RAM and USB resume detecting unit (USB0 only)	Power-on reset circuit and low-power consumption function disabled*6		—	12.5	26		
			Power-on reset circuit and low-power consumption function enabled*7		—	3.1	13.5		
		Increased by RTC operation	When a crystal resonator for low clock loads is in use		—	0.6	—		
			When a crystal resonator for standard clock loads is in use		—	2.0	—		
	RTC operating while VCC is off (with the battery backup function, only the RTC and sub-clock oscillator operate)		When a crystal resonator for low clock loads is in use		—	0.9	—		V_{BATT} = 2.0 V, VCC = 0 V
					—	1.6	—		V_{BATT} = 3.3 V, VCC = 0 V
			When a crystal resonator for standard clock loads is in use		—	1.7	—		V_{BATT} = 2.0 V, VCC = 0 V
					—	3.3	—		V_{BATT} = 3.3 V, VCC = 0 V

Note 1. Supply current values are with all output pins unloaded and all input pull-up MOSs in the off state.
Note 2. Supply of the clock signal to peripheral modules is stopped in this state. This does not include operations as BGO (background operations).
Note 3. I_{CC} depends on f (ICLK) as follows. (ICLK/PCLKA:PCLKB/PCLKC/PCLKD:BCLK:BCLK pin = 10:5:10:5 when EXTAL = 12 MHz)
I_{CC} Max. = 0.77 × f + 18 (max. operation in high-speed operating mode)
I_{CC} Typ. = 0.08 × f + 6 (normal operation in high-speed operating mode)
I_{CC} Typ. = 0.5 × f + 2.6 (low-speed operating mode 1)
I_{CC} Max. = 0.36 × f + 18 (sleep mode)
Note 4. This does not include operations as BGO (background operations). Whether supply of the clock signal to peripheral modules continues or is stopped only depends on the state determined by the settings of the bits in module stop control registers A to D. The setting for the peripheral module clock stopped state is FCLK = BCLK = PCLKA = PCLKB = PCLKC = PCLKD = BCLK pin = 3.75 MHz (division by 64).
Note 5. This is the increase for programming or erasure of the code flash memory (limitations apply to the combinations of ranges in which writing proceed) or data flash memory during program execution in the code flash memory.
Note 6. The low power consumption function is disabled and DEEPCUT[1:0] = 01b.
Note 7. The low power consumption function is enabled and DEEPCUT[1:0] = 11b.

Table 5.12 EXTAL Clock Timing

Conditions: VCC = AVCC0 = AVCC1 = VCC_USB = V_{BATT} = 2.7 to 3.6 V, 2.7 ≤ VREFH0 ≤ AVCC0,
VCC_USBA = AVCC_USBA = 3.0 to 3.6 V,
VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = VSS1_USBA = VSS2_USBA = PVSS_USBA = AVSS_USBA = 0 V,
$T_a = T_{opr}$

Item	Symbol	Min.	Typ.	Max.	Unit	Test Conditions
EXTAL external clock input cycle time	t_{EXcyc}	41.66	—	—	ns	Figure 5.4
EXTAL external clock input high pulse width	t_{EXH}	15.83	—	—	ns	
EXTAL external clock input low pulse width	t_{EXL}	15.83	—	—	ns	
EXTAL external clock rising time	t_{EXr}	—	—	5	ns	
EXTAL external clock falling time	t_{EXf}	—	—	5	ns	

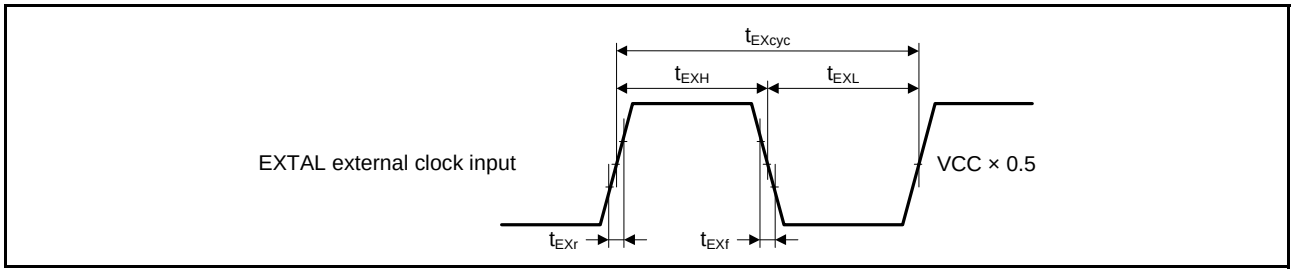


Figure 5.4 EXTAL External Clock Input Timing

Table 5.13 Main Clock Timing

Conditions: VCC = AVCC0 = AVCC1 = VCC_USB = V_{BATT} = 2.7 to 3.6 V, 2.7 ≤ VREFH0 ≤ AVCC0,
VCC_USBA = AVCC_USBA = 3.0 to 3.6 V,
VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = VSS1_USBA = VSS2_USBA = PVSS_USBA = AVSS_USBA = 0 V,
$T_a = T_{opr}$

Item	Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Main clock oscillation frequency	f_{MAIN}	8	—	24	MHz	
Main clock oscillator stabilization time (crystal)	$t_{MAINOSC}$	—	—	—*1	ms	Figure 5.5
Main clock oscillation stabilization wait time (crystal)	$t_{MAINOSCWT}$	—	—	—*2	ms	

Note 1. When using a main clock, ask the manufacturer of the oscillator to evaluate its oscillation. Refer to the results of evaluation provided by the manufacturer for the oscillation stabilization time.

Note 2. The number of cycles selected by the value of the MOSCWTCR.MSTS[7:0] bits determines the main clock oscillation stabilization wait time in accord with the formula below.
$t_{MAINOSCWT}$ = [(MSTS[7:0] bits × 32) + 10] / f_{LOCO}

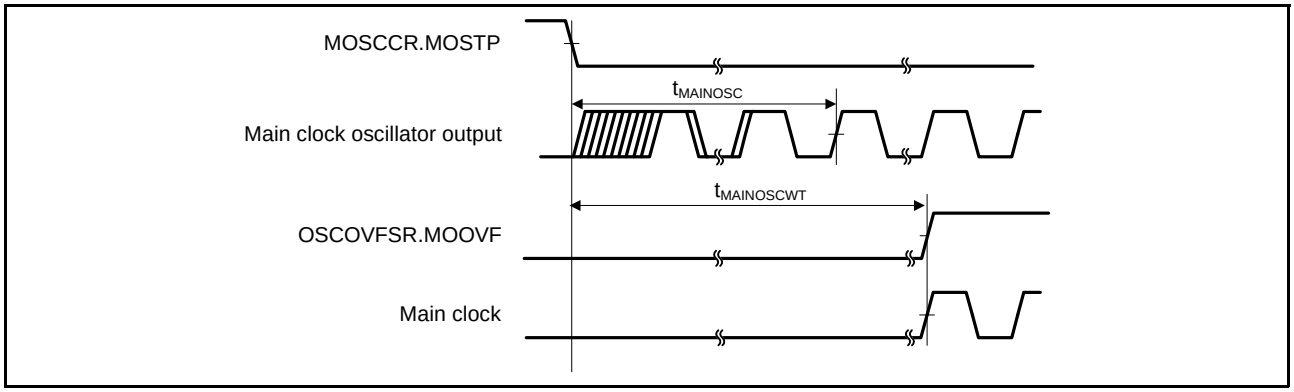


Figure 5.5 Main Clock Oscillation Start Timing

Table 5.15 HOCO Clock Timing

Conditions: VCC = AVCC0 = AVCC1 = VCC_USB = V_{BATT} = 2.7 to 3.6 V, 2.7 ≤ VREFH0 ≤ AVCC0,
VCC_USBA = AVCC_USBA = 3.0 to 3.6 V,
VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = VSS1_USBA = VSS2_USBA = PVSS_USBA = AVSS_USBA = 0 V,
$T_a = T_{opr}$

Item	Symbol	Min.	Typ.	Max.	Unit	Test Conditions
HOCO clock oscillation frequency	f_{HOCO}	15.61	16	16.39	MHz	-20°C ≤ Ta ≤ 85°C
		17.56	18	18.44	MHz	
		19.52	20	20.48	MHz	
		15.52	16	16.48	MHz	-40°C ≤ T_a < -20°C
		17.46	18	18.54	MHz	
		19.40	20	20.60	MHz	
HOCO clock oscillation stabilization wait time	t_{HOCOWT}	—	105	149	µs	Figure 5.8
HOCO clock power supply stabilization time	t_{HOCOP}	—	—	150	µs	Figure 5.9

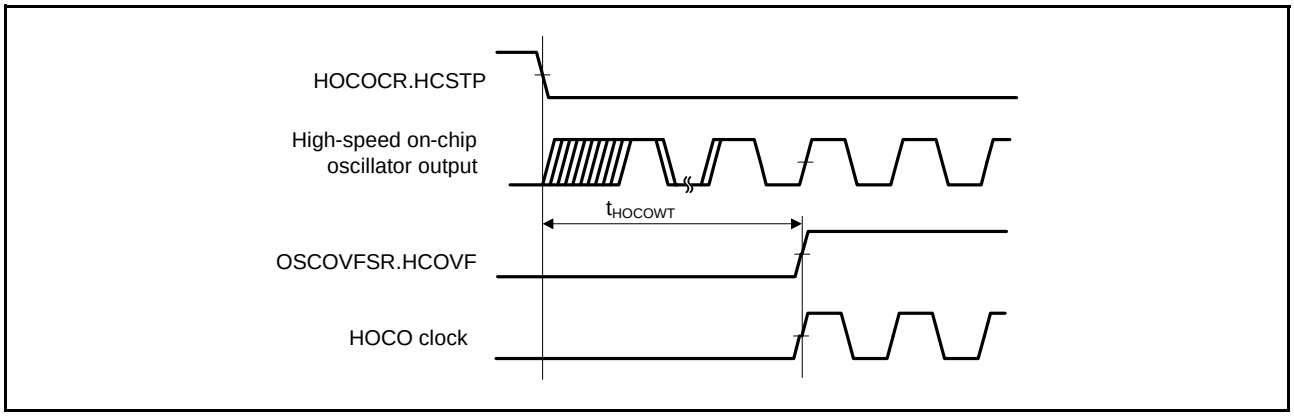


Figure 5.8 HOCO Clock Oscillation Start Timing (Oscillation is Started by Setting the HOCOCR.HCSTP Bit)

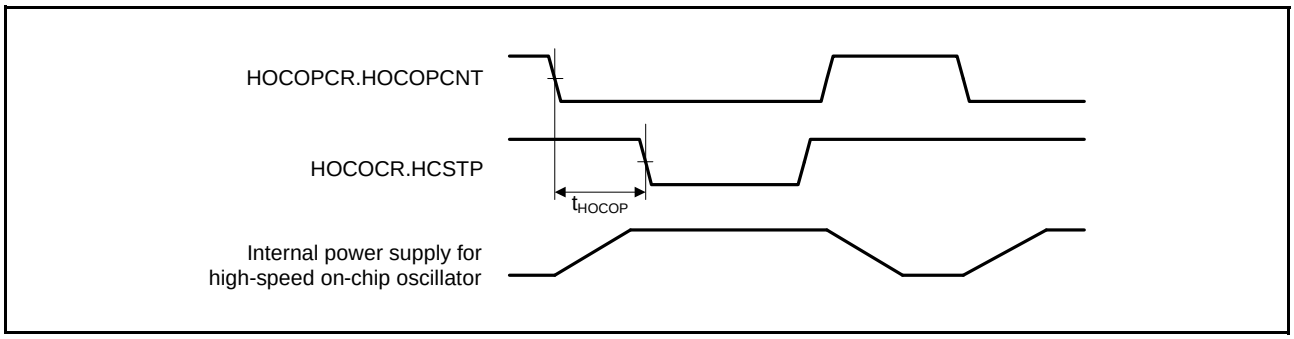


Figure 5.9 High-Speed On-Chip Oscillator Power Supply Control Timing

Table 5.30 A/D Converter Trigger Timing

Conditions: VCC = AVCC0 = AVCC1 = VCC_USB = V_{BATT} = 2.7 to 3.6 V, 2.7 ≤ VREFH0 ≤ AVCC0,
VCC_USBA = AVCC_USBA = 3.0 to 3.6 V,
VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = VSS1_USBA = VSS2_USBA = PVSS_USBA = AVSS_USBA = 0 V,
PCLKA = 8 to 120 MHz, PCLKB = 8 to 60 MHz, $T_a = T_{opr}$
Output load conditions: V_{OH} = VCC × 0.5, V_{OL} = VCC × 0.5, C = 30 pF
High-drive output is selected by the driving ability control register.

Item		Symbol	Min.	Max.	Unit*1	Test Conditions
A/D converter	A/D converter trigger input pulse width	t_{TRGW}	1.5	—	t_{PBcyc}	Figure 5.43

Note 1. t_{PBcyc}: PCLKB cycle

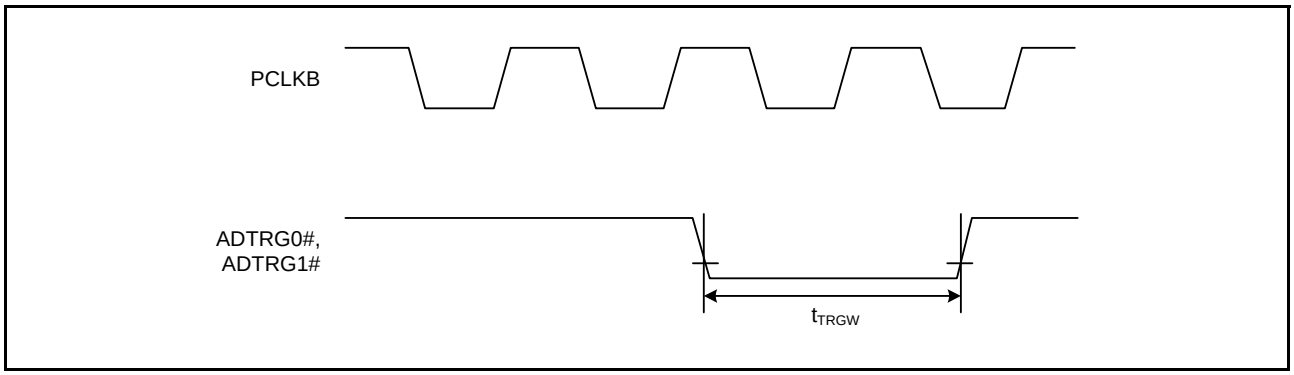


Figure 5.43 A/D Converter Trigger Input Timing

Table 5.31 CAC Timing

Conditions: VCC = AVCC0 = AVCC1 = VCC_USB = V_{BATT} = 2.7 to 3.6 V, 2.7 ≤ VREFH0 ≤ AVCC0,
VCC_USBA = AVCC_USBA = 3.0 to 3.6 V,
VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = VSS1_USBA = VSS2_USBA = PVSS_USBA = AVSS_USBA = 0 V,
PCLKA = 8 to 120 MHz, PCLKB = 8 to 60 MHz, $T_a = T_{opr}$
Output load conditions: V_{OH} = VCC × 0.5, V_{OL} = VCC × 0.5, C = 30 pF
High-drive output is selected by the driving ability control register.

Item*1, *2			Symbol	Min.*1	Max.	Unit*1	Test Conditions
CAC	CACREF input pulse width	$t_{PBcyc} \le t_{cac}$	t_{CACREF}	4.5 t_{cac} + 3 t_{PBcyc}	—	ns	
		$t_{PBcyc} > t_{cac}$		5 t_{cac} + 6.5 t_{PBcyc}	—		

Note 1. t_{PBcyc}: PCLKB cycle
Note 2. t_{CAC}: CAC count clock source cycle

Table 5.32 SCI and SCIF Timing

Conditions: VCC = AVCC0 = AVCC1 = VCC_USB = V_{BATT} = 2.7 to 3.6 V, 2.7 ≤ VREFH0 ≤ AVCC0,
VCC_USBA = AVCC_USBA = 3.0 to 3.6 V,
VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = VSS1_USBA = VSS2_USBA = PVSS_USBA = AVSS_USBA = 0 V,
PCLKA = 8 to 120 MHz, PCLKB = 8 to 60 MHz, $T_a = T_{opr}$
Output load conditions: V_{OH} = VCC × 0.5, V_{OL} = VCC × 0.5, C = 30 pF
High-drive output is selected by the driving ability control register.

Item			Symbol	Min.*1	Max.*1	Unit*1	Test Conditions
SCI	Input clock cycle	Asynchronous	t_{Scyc}	4	—	t_{PBcyc}	Figure 5.44
		Clock synchronous		6	—		
	Input clock pulse width		t_{SCKW}	0.4	0.6	t_{Scyc}	
	Input clock rise time		t_{SCKr}	—	5	ns	
	Input clock fall time		t_{SCKf}	—	5	ns	
	Output clock cycle	Asynchronous*2	t_{Scyc}	8	—	t_{PBcyc}	
		Clock synchronous		4	—		
	Output clock pulse width		t_{SCKW}	0.4	0.6	t_{Scyc}	
	Output clock rise time		t_{SCKr}	—	5	ns	
	Output clock fall time		t_{SCKf}	—	5	ns	
	Transmit data delay time	Clock synchronous	t_{TXD}	—	28	ns	Figure 5.45
	Receive data setup time	Clock synchronous	t_{RXS}	15	—	ns	
	Receive data hold time	Clock synchronous	t_{RXH}	5	—	ns	
SCIF	Input clock cycle	Asynchronous	t_{Scyc}	4	—	t_{PAcyc}	Figure 5.44
		Clock synchronous		12	—		
	Input clock pulse width		t_{SCKW}	0.4	0.6	t_{Scyc}	
	Input clock rise time		t_{SCKr}	—	5	ns	
	Input clock fall time		t_{SCKf}	—	5	ns	
	Output clock cycle	Asynchronous*3	t_{Scyc}	8	—	t_{PAcyc}	
		Clock synchronous		4	—		
	Output clock pulse width		t_{SCKW}	0.4	0.6	t_{Scyc}	
	Output clock rise time		t_{SCKr}	—	5	ns	
	Output clock fall time		t_{SCKf}	—	5	ns	
	Transmit data delay time	Master	t_{TXD}	—	10	ns	Figure 5.45
		Slave		—	$4 \times t_{PAcyc} + 20$		
	Receive data setup time	Master	t_{RXS}	$3 \times t_{PAcyc} + 20$	—	ns	
		Slave		$t_{PAcyc} + 10$	—		
	Receive data hold time	Master	t_{RXH}	$-3 \times t_{PAcyc} + 5$	—	ns	
		Slave		$2 \times t_{PAcyc} + 10$	—		

Note 1. t_{PBcyc}: PCLKB cycle; t_{PAcyc}: PCLKA cycle
Note 2. When the SEMR.ABCS and SEMR.BGDM bits are set to 1
Note 3. When the SEMR.ABCS0 and SEMR.BGDM bits are set to 1

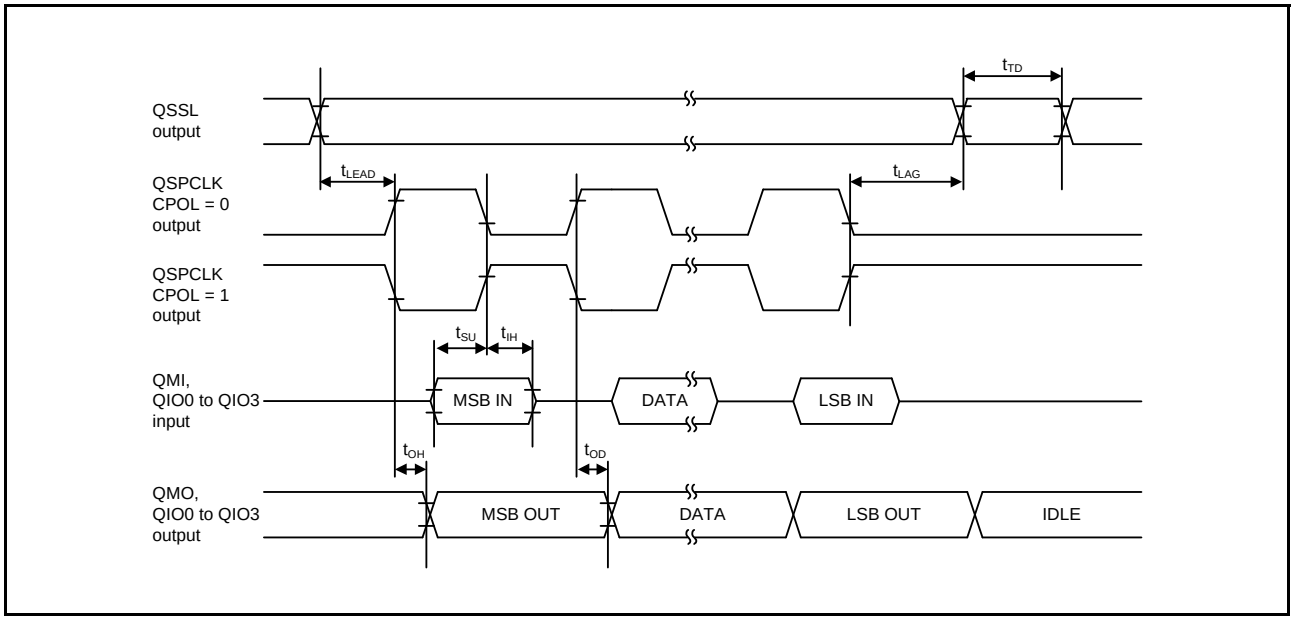


Figure 5.55 Transmit/Receive Timing (CPHA = 1)

5.4 USB Characteristics

Table 5.42 On-Chip USB Low Speed (Host Only) Characteristics (DP and DM Pin Characteristics)

Conditions: VCC = AVCC0 = AVCC1 = VCC_USB = V_{BATT} = 3.0 to 3.6 V, 3.0 ≤ VREFH0 ≤ AVCC0,
VCC_USBA = AVCC_USBA = 3.0 to 3.6 V,
VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = VSS1_USBA = VSS2_USBA = PVSS_USBA = AVSS_USBA = 0 V,
USBA_RREF = 2.2 kΩ ±1%, USBMCLK = 20/24 MHz, UCLK = 48 MHz,
PCLKA = 8 to 120 MHz, PCLKB = 8 to 60 MHz, $T_a = T_{opr}$

Item		Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Input characteristics	Input high level voltage	V_{IH}	2.0	—	—	V	
	Input low level voltage	V_{IL}	—	—	0.8	V	
	Differential input sensitivity	V_{DI}	0.2	—	—	V	| DP – DM |
	Differential common mode range	V_{CM}	0.8	—	2.5	V	
Output characteristics	Output high level voltage	V_{OH}	2.8	—	3.6	V	I_{OH} = –200 µA
	Output low level voltage	V_{OL}	0.0	—	0.3	V	I_{OL} = 2 mA
	Cross-over voltage	V_{CRS}	1.3	—	2.0	V	Figure 5.75
	Rise time	t_{LR}	75	—	300	ns	
	Fall time	t_{LF}	75	—	300	ns	
	Rise/fall time ratio	t_{LR} / t_{LF}	80	—	125	%	t_{LR}/ t_{LF}
Pull-down characteristics	DP/DM pull-down resistance (when the host controller function is selected)	R_{pd}	14.25	—	24.80	kΩ	

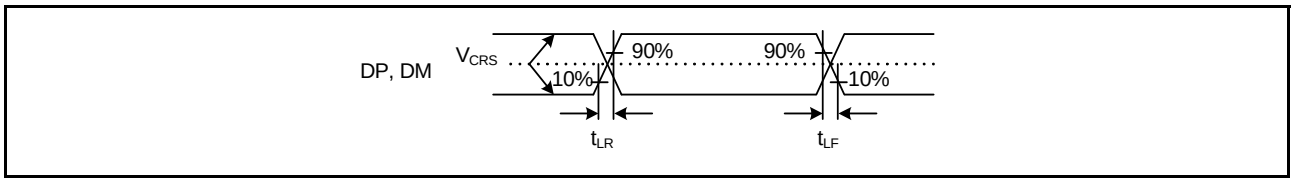


Figure 5.75 DP and DM Output Timing (Low Speed)

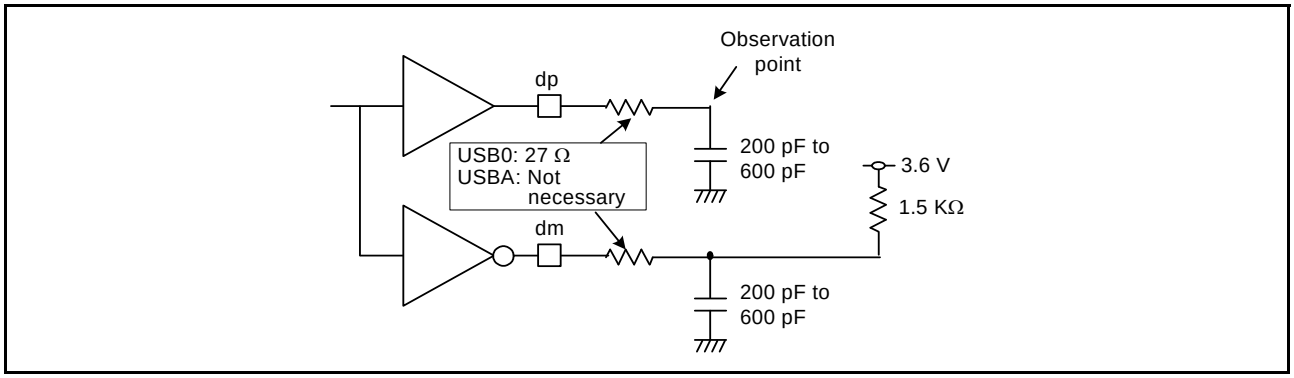


Figure 5.76 Test Circuit (Low Speed)

Table 5.43 On-Chip USB Full-Speed Characteristics (DP and DM Pin Characteristics)

Conditions: VCC = AVCC0 = AVCC1 = VCC_USB = V_{BATT} = 3.0 to 3.6 V, 3.0 ≤ VREFH0 ≤ AVCC0,
VCC_USBA = AVCC_USBA = 3.0 to 3.6 V,
VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = VSS1_USBA = VSS2_USBA = PVSS_USBA = AVSS_USBA = 0 V,
USBA_RREF = 2.2 kΩ ±1%, USBMCLK = 20/24 MHz, UCLK = 48 MHz,
PCLKA = 8 to 120 MHz, PCLKB = 8 to 60 MHz, $T_a = T_{opr}$

Item		Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Input characteristics	Input high level voltage	V_{IH}	2.0	—	—	V	
	Input low level voltage	V_{IL}	—	—	0.8	V	
	Differential input sensitivity	V_{DI}	0.2	—	—	V	| DP – DM |
	Differential common mode range	V_{CM}	0.8	—	2.5	V	
Output characteristics	Output high level voltage	V_{OH}	2.8	—	3.6	V	I_{OH} = –200 µA
	Output low level voltage	V_{OL}	0.0	—	0.3	V	I_{OL} = 2 mA
	Cross-over voltage	V_{CRS}	1.3	—	2.0	V	Figure 5.77
	Rise time	t_{FR}	4	—	20	ns	
	Fall time	t_{FF}	4	—	20	ns	
	Rise/fall time ratio	t_{FR} / t_{FF}	90	—	111.11	%	t_{FR}/ t_{FF}
	Output resistance	Z_{DRV}	28	—	44	Ω	USBFS: Rs = 27 Ω included
			40.5	—	49.5	Ω	USBA: Rs not necessary (PHYSET.REPSEL[1:0] = 01b and PHYSET.HSEB = 0)
Pull-up and pull-down characteristics	DP pull-up resistance (when the function controller function is selected)	R_{pu}	0.900	—	1.575	kΩ	Idle state
			1.425	—	3.090	kΩ	At transmission and reception
	DP/DM pull-down resistance (when the host controller function is selected)	R_{pd}	14.25	—	24.80	kΩ	

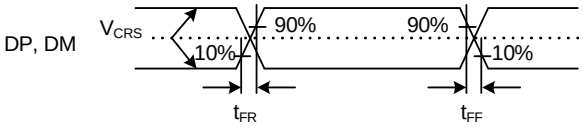


Figure 5.77 DP and DM Output Timing (Full-Speed)

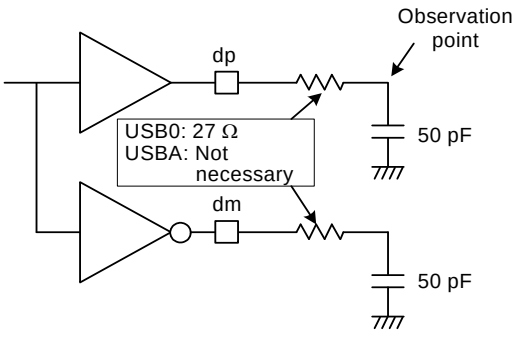
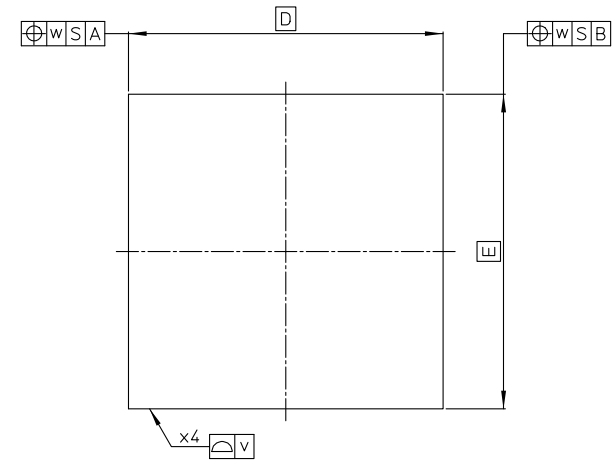
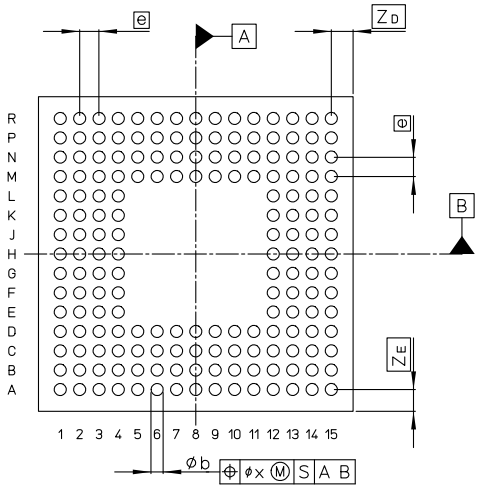


Figure 5.78 Test Circuit (Full-Speed)

JEITA Package Code	RENESAS Code	Previous Code	MASS[Typ.]
P-LFBGA176-13x13-0.80	PLBG0176GA-A	BP-176/BP-176V	0.45g





Reference Symbol	Dimension in Millimeters		
	Min	Nom	Max
D	—	13.0	—
E	—	13.0	—
v	—	—	0.15
w	—	—	0.20
A	—	—	1.40
A_1	0.35	0.40	0.45
e	—	0.80	—
b	0.45	0.50	0.55
x	—	—	0.08
y	—	—	0.10
y_1	—	—	0.2
S_D	—	—	—
S_E	—	—	—
Z_D	—	0.90	—
Z_E	—	0.90	—

Figure B 176-Pin LFBGA (PLBG0176GA-A)

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